

PS9332L, PS9332L2

R08DS0105EJ0100

Rev.1.00

Sep 06, 2013

2.0 A OUTPUT CURRENT, HIGH CMR, IGBT GATE DRIVE, ACTIVE MILLER CLAMP, 8-PIN SDIP PHOTOCOUPLER

DESCRIPTION

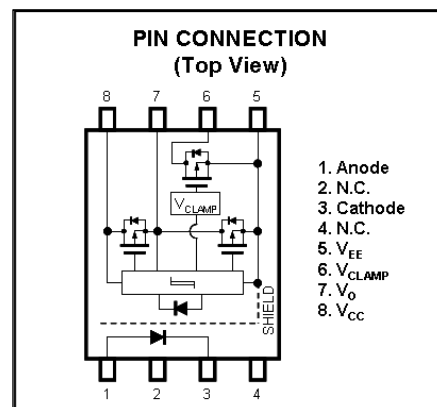
The PS9332L and PS9332L2 are optical coupled isolators containing a GaAlAs LED on the input side and a photo diode, a signal processing circuit and a power output transistor on the output side on one chip.

The PS9332L and PS9332L2 are designed specifically for high common mode transient immunity (CMR), high output current, active miller clamp and high switching speed.

The PS9332L and PS9332L2 are suitable for driving IGBTs and MOS FETs.

FEATURES

- Long creepage distance (8 mm MIN.: PS9332L2)
- Peak output current (2.0 A MAX., 1.5 A MIN.)
- High speed switching (t_{PLH} , t_{PHL} = 200 ns MAX.)
- UVLO (Under Voltage Lock Out) protection with hysteresis
- Built-in Active Miller Clamp
- High common mode transient immunity (CM_H , CM_L = ± 50 kV/ μ s MIN.)
- Operating Ambient Temperature (125 °C)
- Embossed tape product : PS9332L-E3, PS9332L2-E3: 2 000 pcs/reel
- Pb-Free product
- <R> • Safety standards
 - UL approved: No. E72422
 - CSA approved: No. CA 101391 (CA5A, CAN/CSA-C22.2 60065, 60950)
 - SEMKO approved (EN 60065, EN 60950)
 - DIN EN 60747-5-5 (VDE 0884-5) approved (Option)

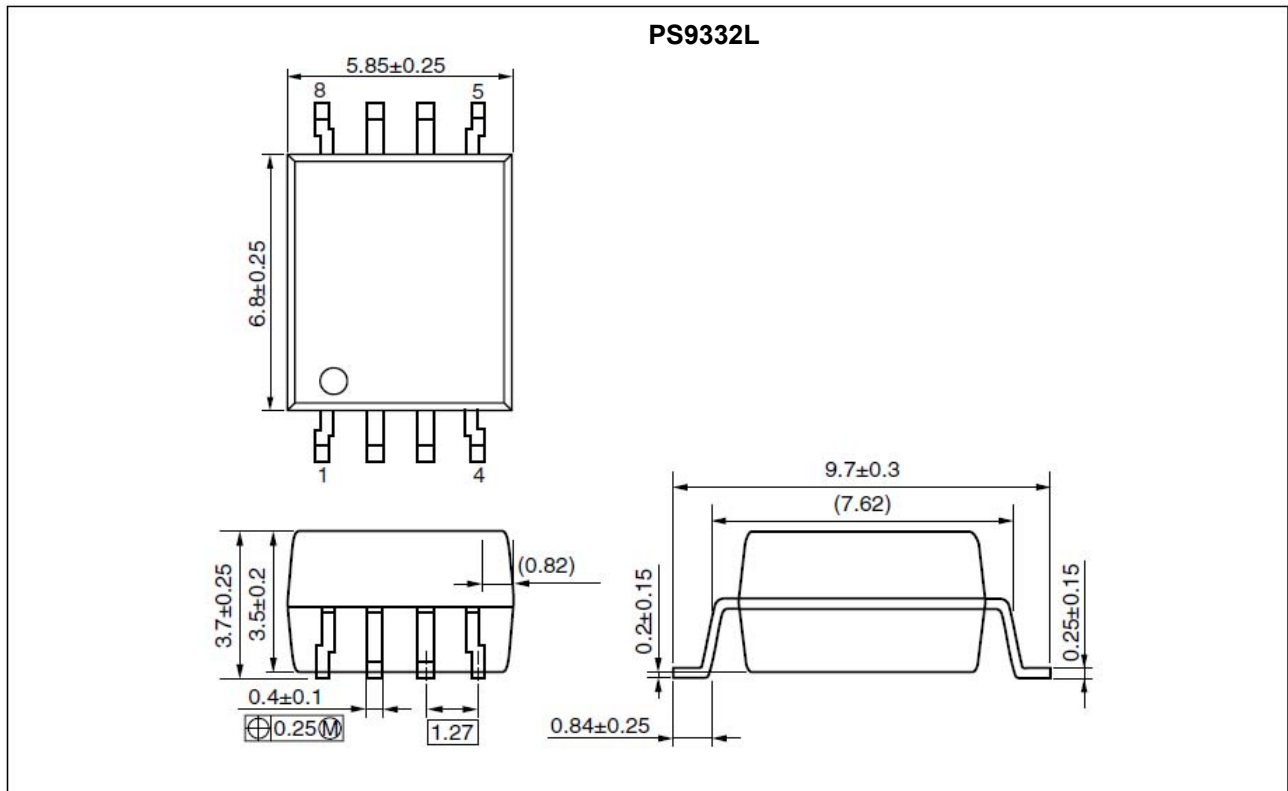
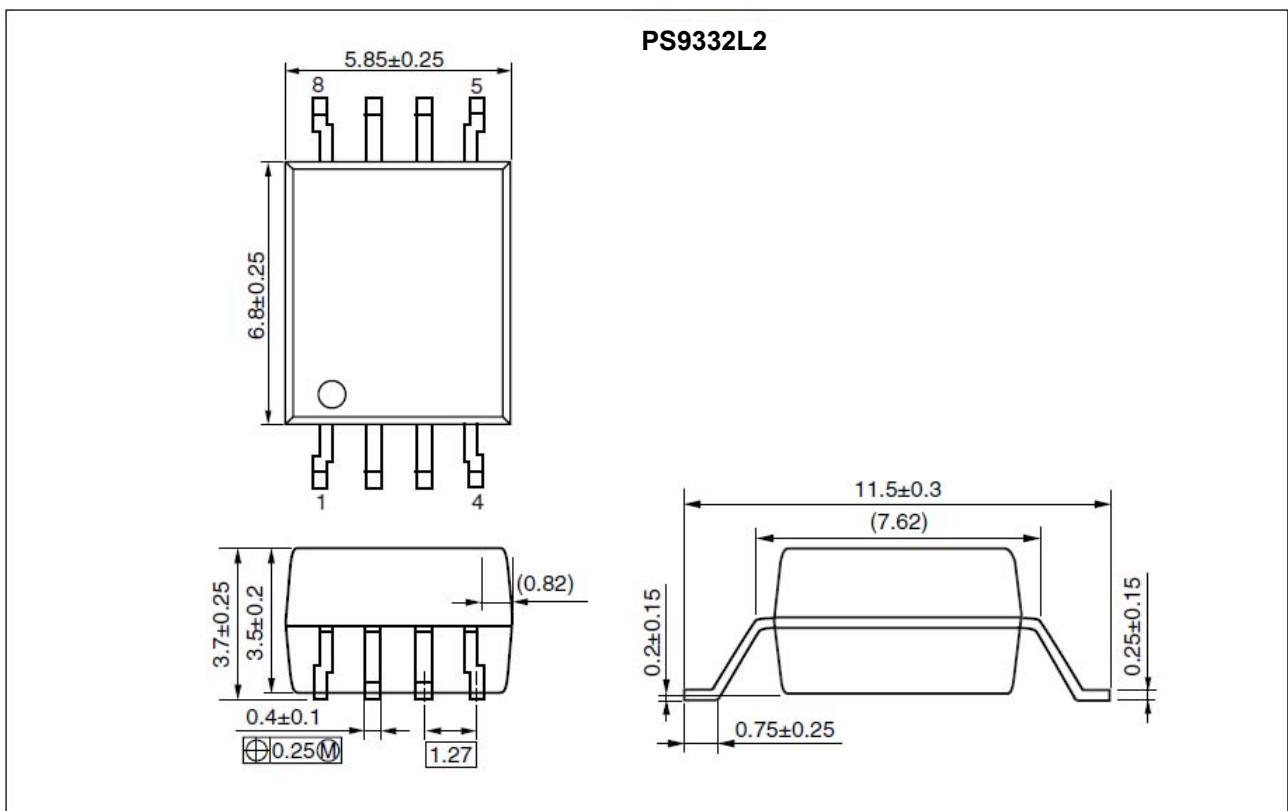


APPLICATIONS

- IGBT, Power MOS FET Gate Driver
- Industrial inverter
- IH (Induction Heating)

The mark <R> shows major revised points.

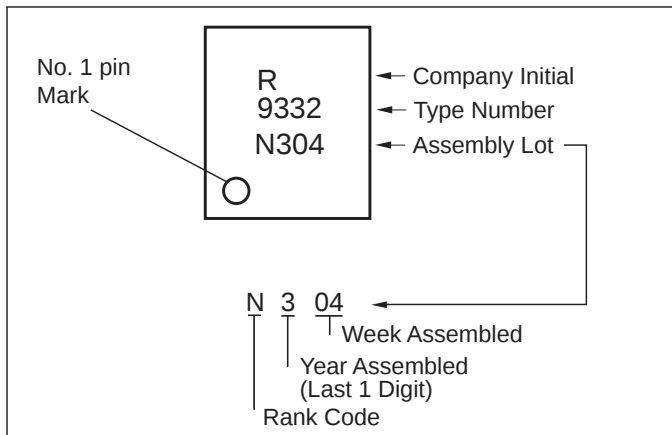
The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

PACKAGE DIMENSIONS (UNIT: mm)**Lead Bending Type (Gull-wing) For Surface Mount****Lead Bending Type (Gull-wing) For Long Creepage Distance (Surface Mount)**

PHOTOCOUPLER CONSTRUCTION

Parameter	PS9332L	PS9332L2
Air Distance (MIN.)	7 mm	8 mm
Outer Creepage Distance (MIN.)	8 mm	8 mm
Isolation Distance (MIN.)	0.4 mm	0.4 mm

MARKING EXAMPLE



<R> ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number ^{*1}
PS9332L	PS9332L-AX	Pb-Free (Ni/Pd/Au)	20 pcs (Tape 20 pcs cut)	Standard products (UL, CSA, SEMKO approved)	PS9332L
PS9332L-E3	PS9332L-E3-AX		Embossed Tape 2 000 pcs/reel		
PS9332L2	PS9332L2-AX		20 pcs (Tape 20 pcs cut)	SEMKO approved)	PS9332L2
PS9332L2-E3	PS9332L2-E3-AX		Embossed Tape 2 000 pcs/reel		
PS9332L-V	PS9332L-V-AX		20 pcs (Tape 20 pcs cut)	DIN EN 60747-5-5 (VDE 0884-5) approved (Option)	PS9332L
PS9332L-V-E3	PS9332L-V-E3-AX		Embossed Tape 2 000 pcs/reel		
PS9332L2-V	PS9332L2-V-AX		20 pcs (Tape 20 pcs cut)		PS9332L2
PS9332L2-V-E3	PS9332L2-V-E3-AX		Embossed Tape 2 000 pcs/reel		

Note: ^{*1}. For the application of the Safety Standard, following part number should be used.

<R> **ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$, unless otherwise specified)**

Parameter		Symbol	Ratings	Unit
Diode	Forward Current	I_F	25	mA
	Peak Transient Forward Current (Pulse Width $< 1\ \mu\text{s}$)	$I_{F(\text{TRAN})}$	1.0	A
	Reverse Voltage	V_R	5	V
	Power Dissipation ^{*1}	P_D	45	mW
Detector	High Level Peak Output Current ^{*2}	$I_{OH(\text{PEAK})}$	2.0	A
	Low Level Peak Output Current ^{*2}	$I_{OL(\text{PEAK})}$	2.0	A
	Supply Voltage	$(V_{CC} - V_{EE})$	0 to 35	V
	Output Voltage	V_O	-0.5 to V_{CC}	V
	Peak Clamp Sink Current	I_{CLAMP}	2.0	A
	Miller Clamping Pin Voltage	V_{CLAMP}	-0.5 to V_{CC}	V
	Power Dissipation ^{*3}	P_C	250	mW
Isolation Voltage ^{*4}		BV	5 000	Vr.m.s.
Operating Frequency ^{*5}		f	50	kHz
Operating Ambient Temperature		T_A	-40 to +125	$^\circ\text{C}$
Storage Temperature		T_{stg}	-55 to +150	$^\circ\text{C}$

Notes: *1. Reduced to 1.1 mW/ $^\circ\text{C}$ at $T_A = 105^\circ\text{C}$ or more.

*2. Maximum pulse width = 10 μs , Maximum duty cycle = 0.2%

*3. Reduced to 5.5 mW/ $^\circ\text{C}$ at $T_A = 105^\circ\text{C}$ or more.

*4. AC voltage for 1 minute at $T_A = 25^\circ\text{C}$, RH = 60% between input and output.

Pins 1-4 shorted together, 5-8 shorted together.

*5. $I_{OH(\text{PEAK})} \leq 2.0\text{ A}$ ($\leq 0.3\ \mu\text{s}$), $I_{OL(\text{PEAK})} \leq 2.0\text{ A}$ ($\leq 0.3\ \mu\text{s}$)

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Supply Voltage	$(V_{CC} - V_{EE})$	15		30	V
Forward Current (ON)	$I_{F(\text{ON})}$	7		16	mA
Forward Voltage (OFF)	$V_{F(\text{OFF})}$	-2		0.8	V
Operating Ambient Temperature	T_A	-40		125	$^\circ\text{C}$

<R> **ELECTRICAL CHARACTERISTICS (at RECOMMENDED OPERATING CONDITIONS, $V_{EE} = \text{GND}$, unless otherwise specified)**

Parameter		Symbol	Conditions	MIN.	TYP.*1	MAX.	Unit
Diode	Forward Voltage	V_F	$I_F = 10 \text{ mA}$, $T_A = 25^\circ\text{C}$	1.35	1.56	1.75	V
	Reverse Current	I_R	$V_R = 3 \text{ V}$, $T_A = 25^\circ\text{C}$			10	μA
	Input Capacitance	C_{IN}	$f = 1 \text{ MHz}$, $V_F = 0 \text{ V}$, $T_A = 25^\circ\text{C}$		30		pF
Detector	High Level Output Current	I_{OH}	$V_O = (V_{CC} - 4 \text{ V})^{*2}$	0.5	1.5		A
			$V_O = (V_{CC} - 15 \text{ V})^{*3}$	1.5			
	Low Level Output Current	I_{OL}	$V_O = (V_{EE} + 2.5 \text{ V})^{*2}$	0.5	1.5		A
			$V_O = (V_{EE} + 15 \text{ V})^{*3}$	1.5			
	Clamp Output Peak Current	I_{CLAMP}	$V_{CLAMP} = V_{EE} + 2.5 \text{ V}$	0.5	1.6		A
	Clamp Pin Threshold Voltage	V_{tCLAMP}			3.0		V
	High Level Output Voltage	V_{OH}	$I_O = -100 \text{ mA}^{*4}$	$V_{CC} - 3.0$	$V_{CC} - 1.3$		V
	Low Level Output Voltage	V_{OL}	$I_O = 100 \text{ mA}$		0.1	0.5	V
	High Level Supply Current	I_{CCH}	$I_F = 10 \text{ mA}$, $V_O = \text{open}$		1.5	2.5	mA
	Low Level Supply Current	I_{CCL}	$V_F = 0$ to 0.8 V , $V_O = \text{open}$		1.5	2.5	mA
	UVLO Threshold Voltage	V_{UVLO+}	$V_O > 5 \text{ V}$, $I_F = 10 \text{ mA}$	10.8	12.4	13.4	V
		V_{UVLO-}	$V_O < 5 \text{ V}$, $I_F = 10 \text{ mA}$	9.5	11.2	12.5	
	UVLO Hysteresis	$UVLO_{HYS}$	$(V_{UVLO+}) - (V_{UVLO-})$		1.2		
Coupled	Threshold Input Current (L $\rightarrow$ H)	I_{FLH}	$I_O = 0 \text{ mA}$, $V_O > 5 \text{ V}$		1.5	4.0	mA
	Threshold Input Voltage (H $\rightarrow$ L)	V_{FHL}	$I_O = 0 \text{ mA}$, $V_O < 5 \text{ V}$	0.8			V

Notes: *1. Typical values at $T_A = 25^\circ\text{C}$.

*2. Maximum pulse width = $50 \mu\text{s}$, Maximum duty cycle = 0.5%.

*3. Maximum pulse width = $10 \mu\text{s}$, Maximum duty cycle = 0.2%.

*4. V_{OH} is measured with the DC load current in this testing. (Maximum pulse width = 2 ms, Maximum duty cycle = 20%)

<R> **SWITCHING CHARACTERISTICS (at RECOMMENDED OPERATING CONDITIONS, $V_{EE} = \text{GND}$, unless otherwise specified)**

Parameter	Symbol	Conditions	MIN.	TYP.*1	MAX.	Unit
Propagation Delay Time (L $\rightarrow$ H)	t_{PLH}	$R_g = 10 \Omega$, $C_g = 10 \text{ nF}$, $f = 10 \text{ kHz}$, Duty Cycle = 50% ^{*2} , $I_F = 10 \text{ mA}$		75	200	ns
Propagation Delay Time (H $\rightarrow$ L)	t_{PHL}			110	200	ns
Pulse Width Distortion (PWD)	$ t_{PHL} - t_{PLH} $			35	75	ns
Propagation Delay Time (Difference Between Any Two Products)	$t_{PHL} - t_{PLH}$		-90		90	ns
Rise Time	t_r			17		ns
Fall Time	t_f			17		ns
Common Mode Transient Immunity at High Level Output	$ CM_H $	$T_A = 25^\circ\text{C}$, $I_F = 10 \text{ mA}$, $V_{CC} = 30 \text{ V}$, $V_{CM} = 1.5 \text{ kV}$ $V_{O(MIN.)} = 26 \text{ V}$	50			kV/ μs
Common Mode Transient Immunity at Low Level Output	$ CM_L $	$T_A = 25^\circ\text{C}$, $I_F = 0 \text{ mA}$, $V_{CC} = 30 \text{ V}$, $V_{CM} = 1.5 \text{ kV}$ $V_{O(MAX.)} = 1 \text{ V}$	50			kV/ μs

Notes: *1. Typical values at $T_A = 25^\circ\text{C}$.

*2. This load condition is equivalent to the IGBT load at 1 200 V/75 A.

<R> TEST CIRCUIT

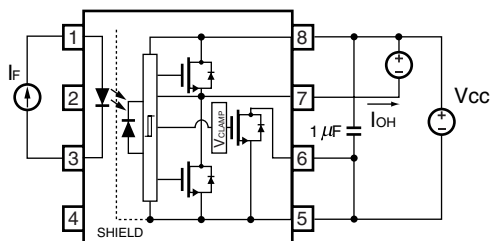
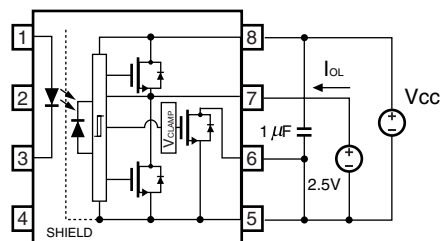
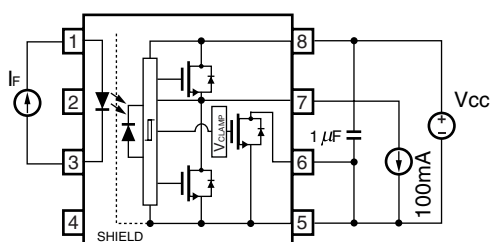
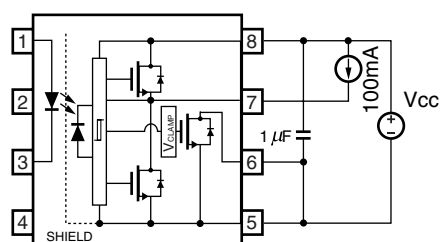
Fig. 1 I_{OH} Test CircuitFig. 2 I_{OL} Test CircuitFig. 3 V_{OH} Test CircuitFig. 4 V_{OL} Test Circuit

Fig. 5 UVLO Test Circuit

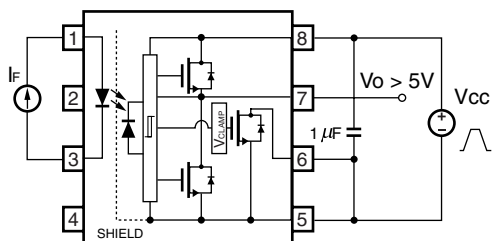
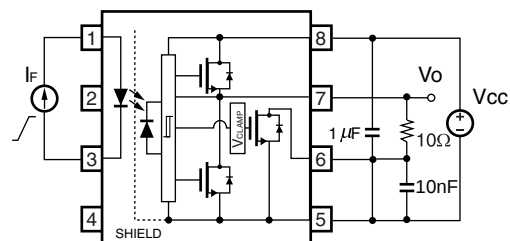
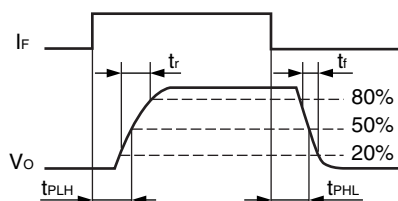
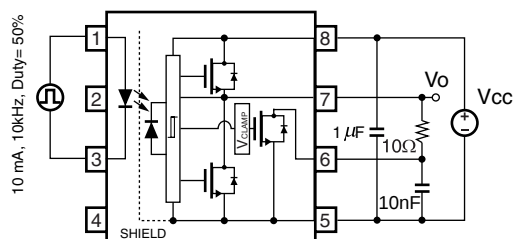
Fig. 6 I_{FLH} Test CircuitFig. 7 $t_{PLH}/t_{PHL}/t_r/t_f$ Test Circuit and Wave Forms

Fig. 8 CMR Test Circuit and Wave Forms

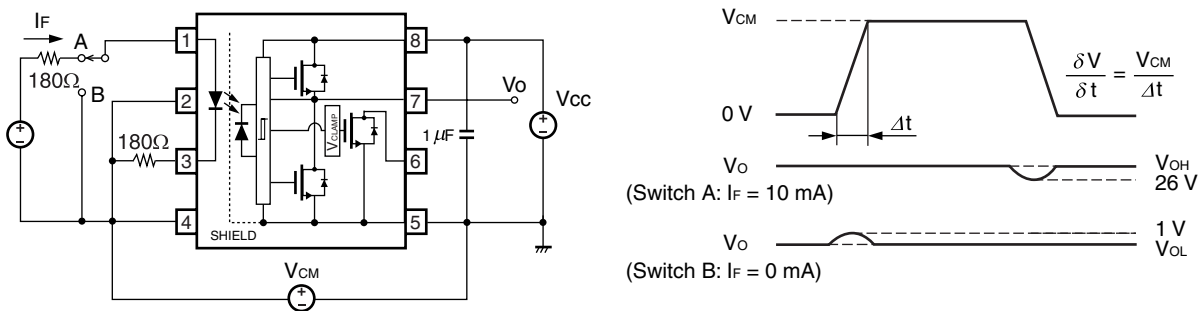


Fig. 9 I_{CLAMP} Test Circuit

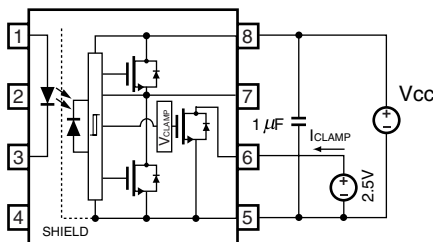
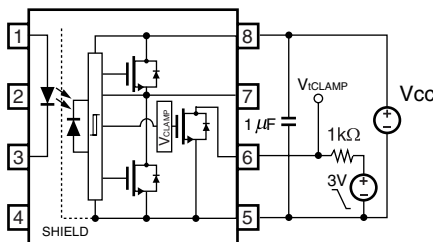
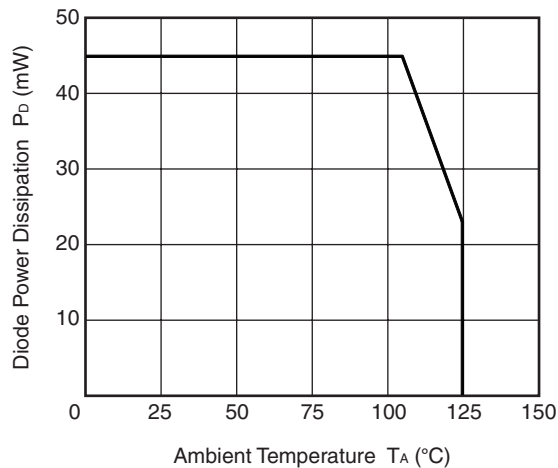
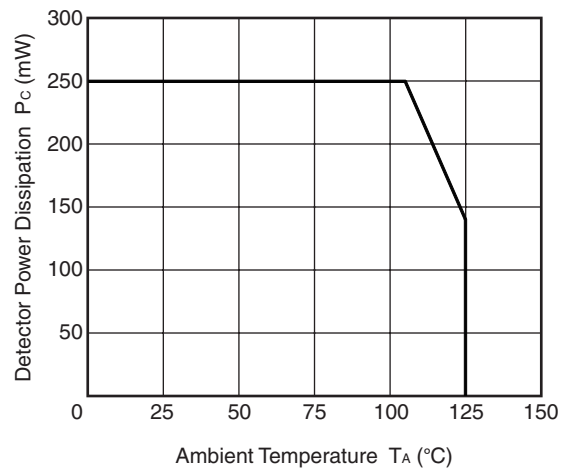
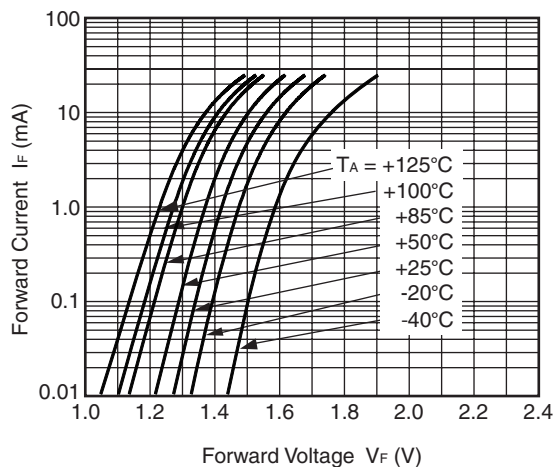
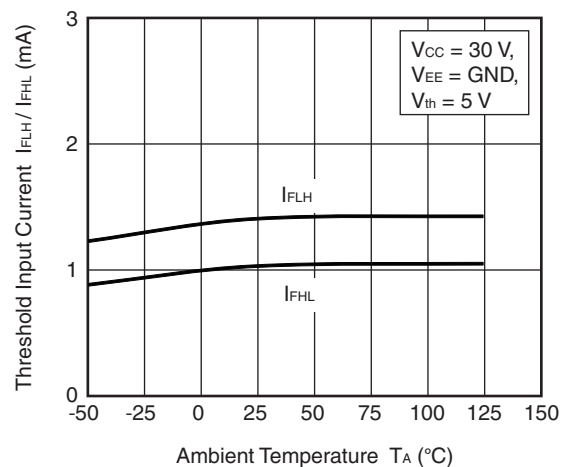
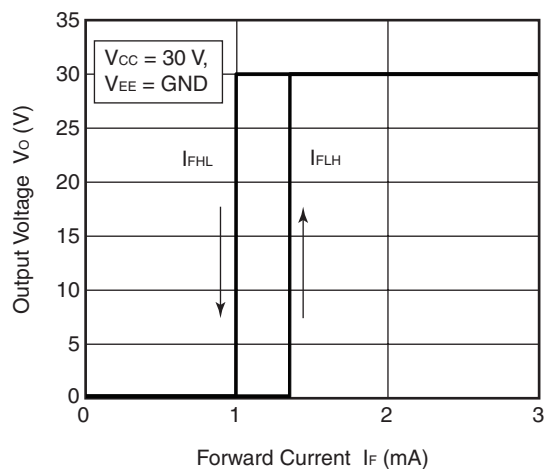
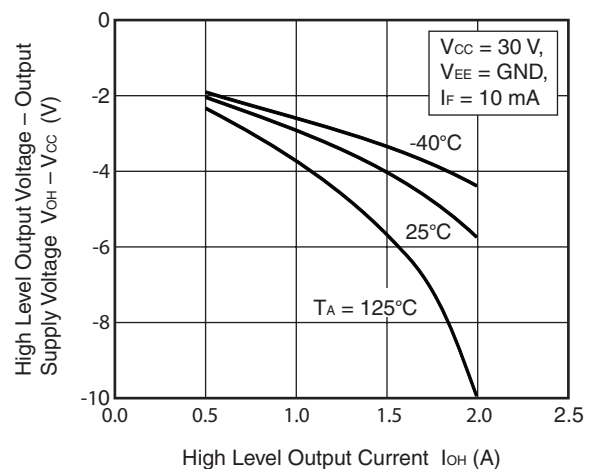


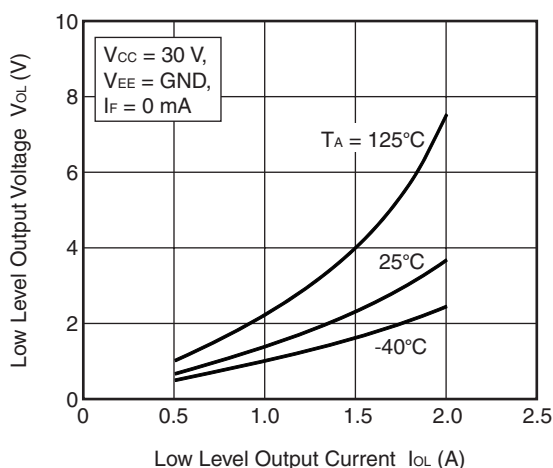
Fig. 10 V_{tCLAMP} Test Circuit



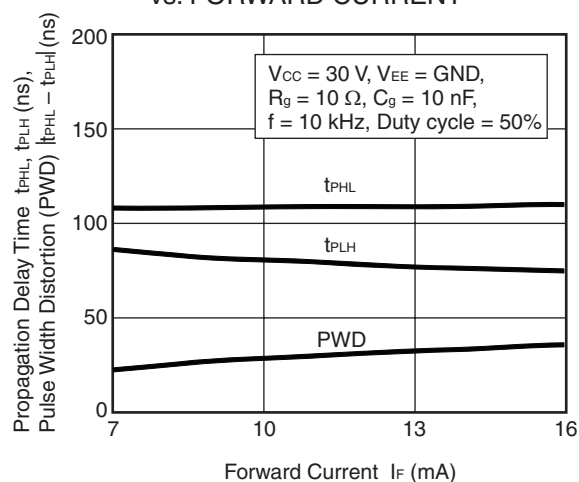
<R> **TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$, unless otherwise specified)****DIODE POWER DISSIPATION
vs. AMBIENT TEMPERATURE****DETECTOR POWER DISSIPATION
vs. AMBIENT TEMPERATURE****FORWARD CURRENT vs.
FORWARD VOLTAGE****THRESHOLD INPUT CURRENT vs.
AMBIENT TEMPERATURE****OUTPUT VOLTAGE vs.
FORWARD CURRENT****HIGH LEVEL OUTPUT VOLTAGE – OUTPUT SUPPLY
VOLTAGE vs. HIGH LEVEL OUTPUT CURRENT**

Remark The graphs indicate nominal characteristics.

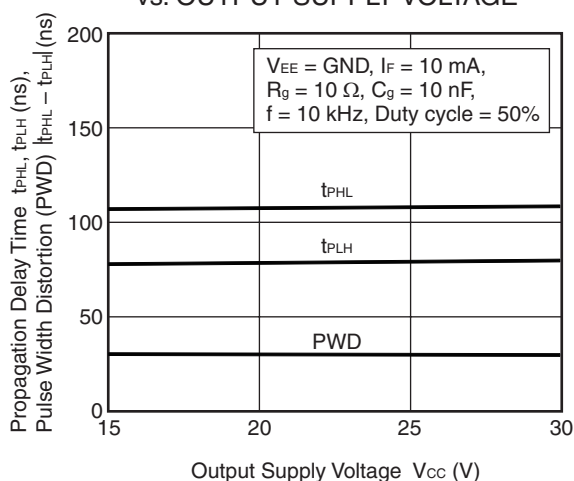
LOW LEVEL OUTPUT VOLTAGE vs.
LOW LEVEL OUTPUT CURRENT



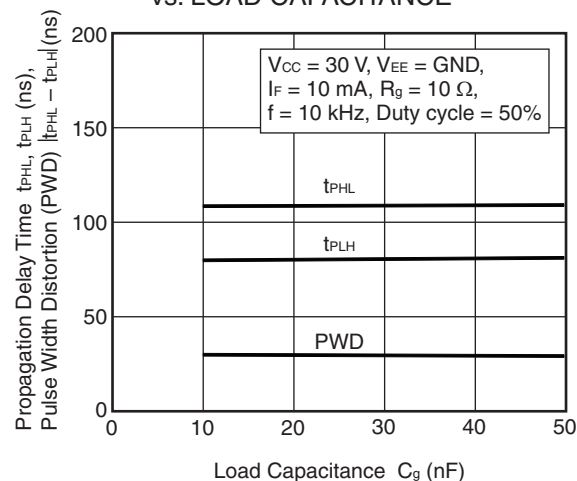
PROPAGATION DELAY TIME,
PULSE WIDTH DISTORTION
vs. FORWARD CURRENT



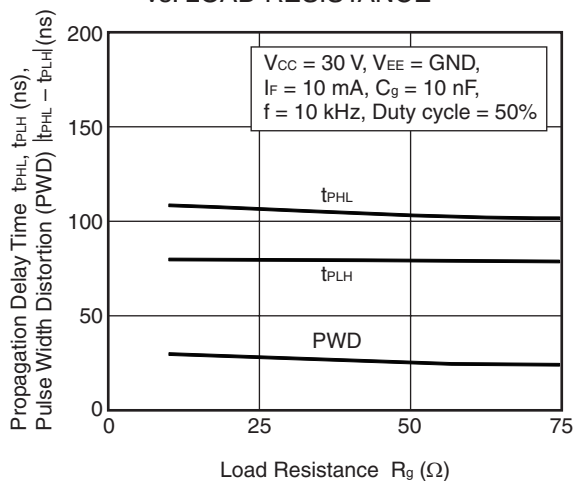
PROPAGATION DELAY TIME,
PULSE WIDTH DISTORTION
vs. OUTPUT SUPPLY VOLTAGE



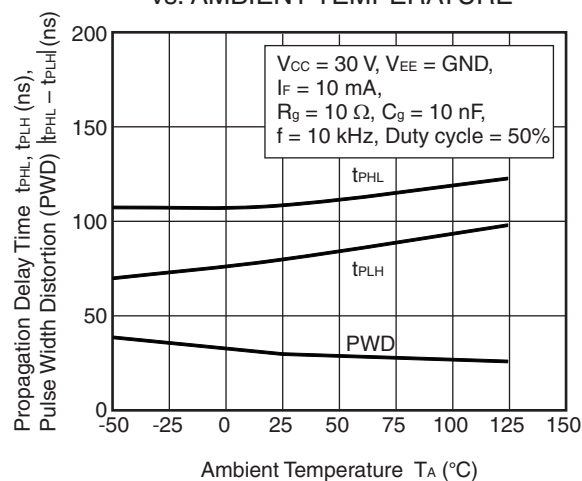
PROPAGATION DELAY TIME,
PULSE WIDTH DISTORTION
vs. LOAD CAPACITANCE



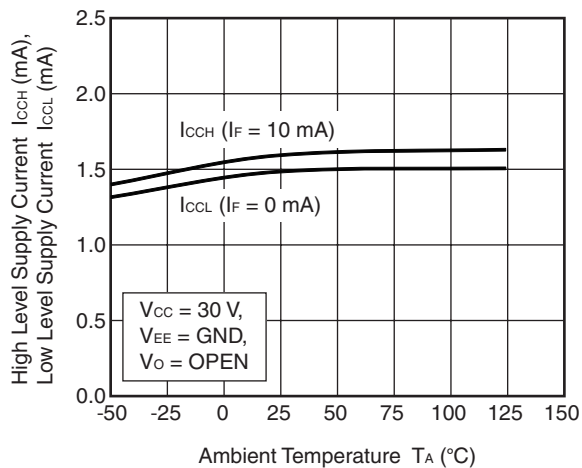
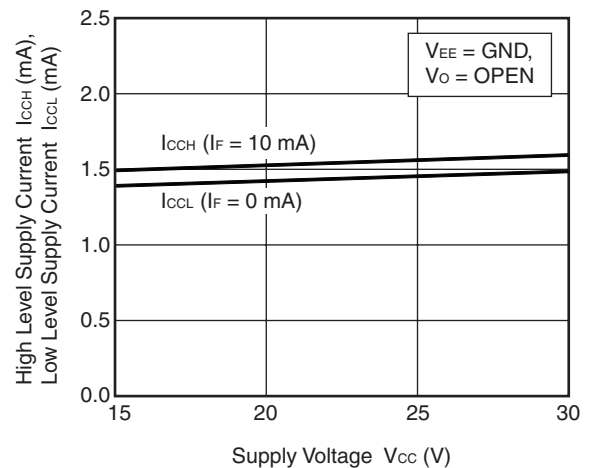
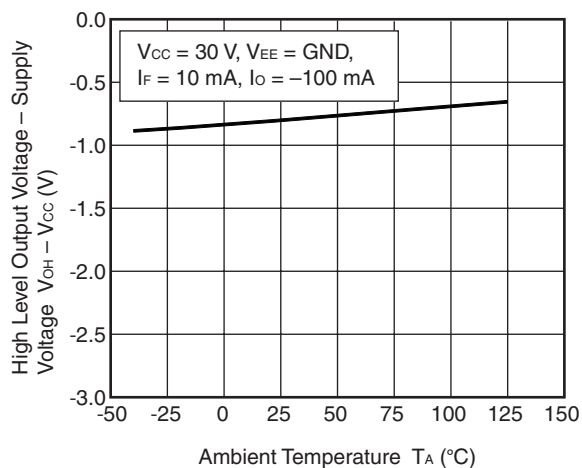
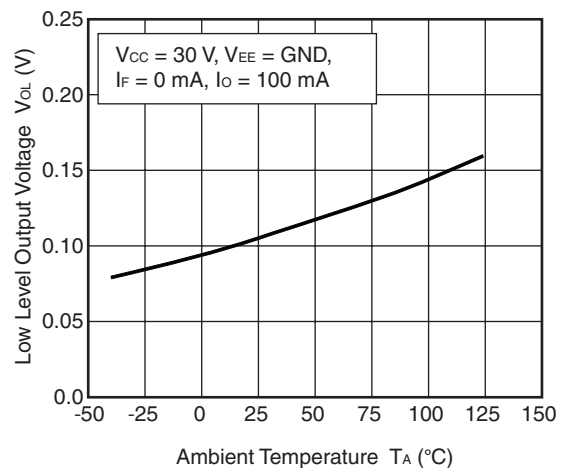
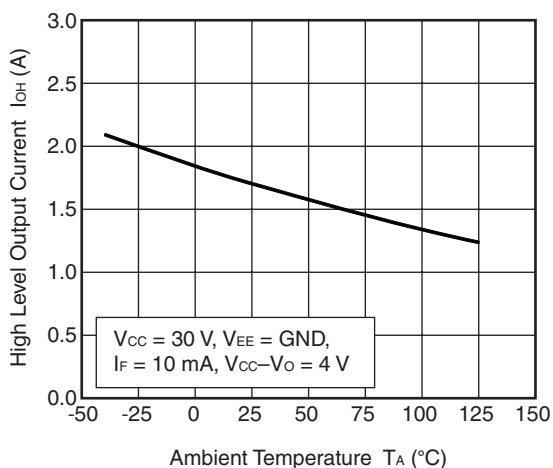
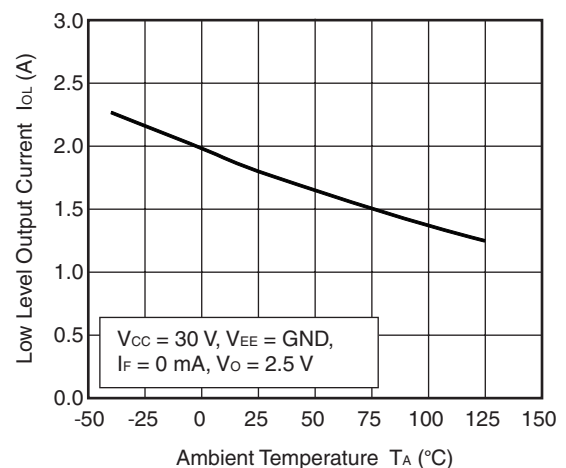
PROPAGATION DELAY TIME,
PULSE WIDTH DISTORTION
vs. LOAD RESISTANCE



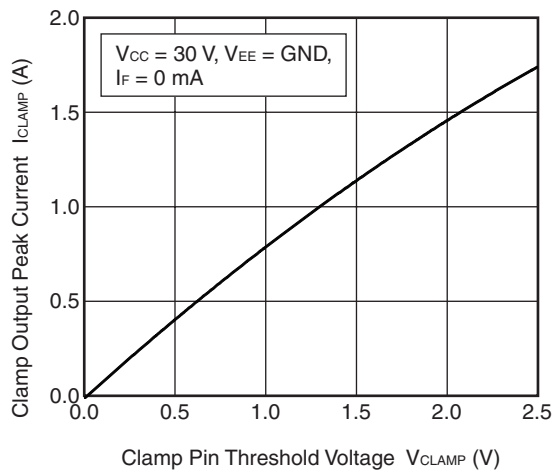
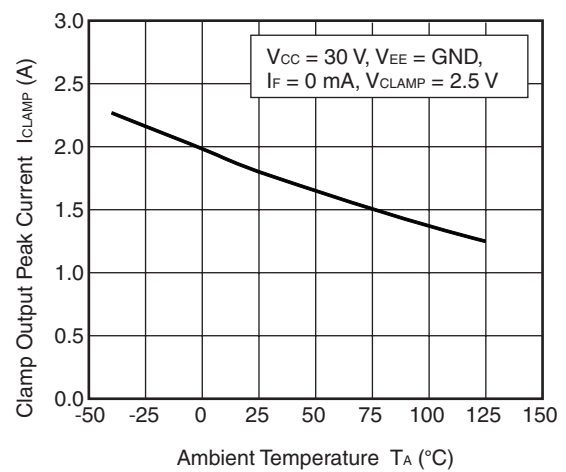
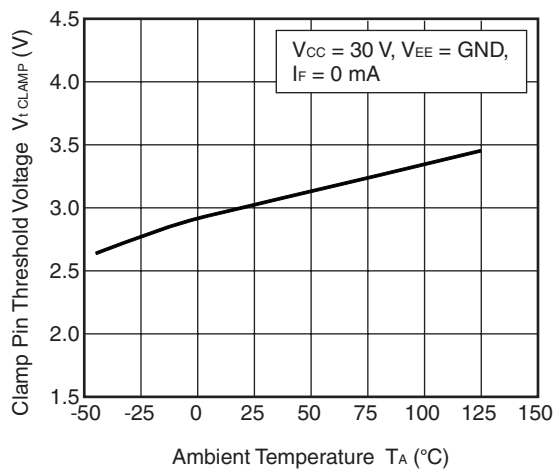
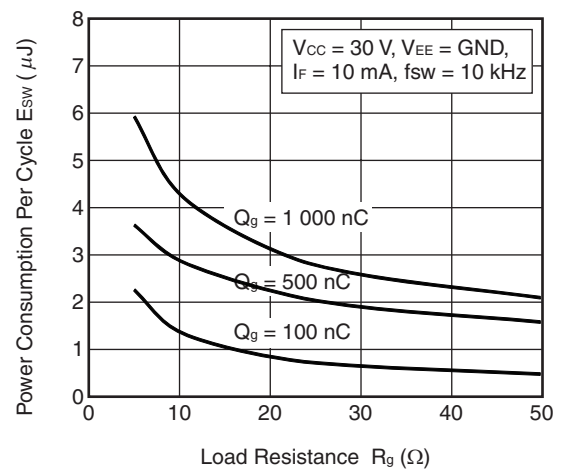
PROPAGATION DELAY TIME,
PULSE WIDTH DISTORTION
vs. AMBIENT TEMPERATURE



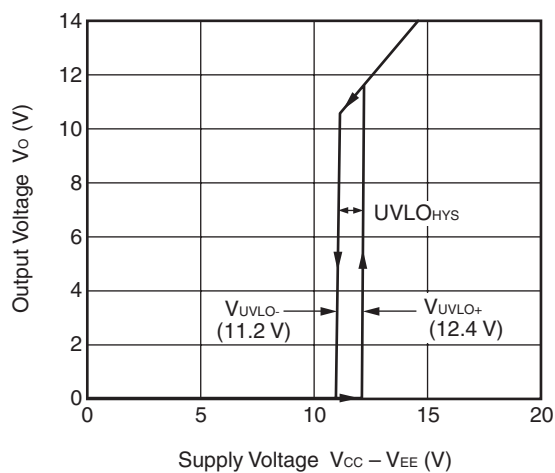
Remark The graphs indicate nominal characteristics.

SUPPLY CURRENT vs.
AMBIENT TEMPERATURESUPPLY CURRENT vs.
SUPPLY VOLTAGEHIGH LEVEL OUTPUT VOLTAGE – SUPPLY
VOLTAGE vs. AMBIENT TEMPERATURELOW LEVEL OUTPUT VOLTAGE vs.
AMBIENT TEMPERATUREHIGH LEVEL OUTPUT CURRENT vs.
AMBIENT TEMPERATURELOW LEVEL OUTPUT CURRENT vs.
AMBIENT TEMPERATURE

Remark The graphs indicate nominal characteristics.

CLAMP OUTPUT PEAK CURRENT vs.
CLAMP PIN THRESHOLD VOLTAGECLAMP OUTPUT PEAK CURRENT vs.
AMBIENT TEMPERATURECLAMP PIN THRESHOLD VOLTAGE
vs. AMBIENT TEMPERATUREPOWER CONSUMPTION PER CYCLE
vs. LOAD RESISTANCE

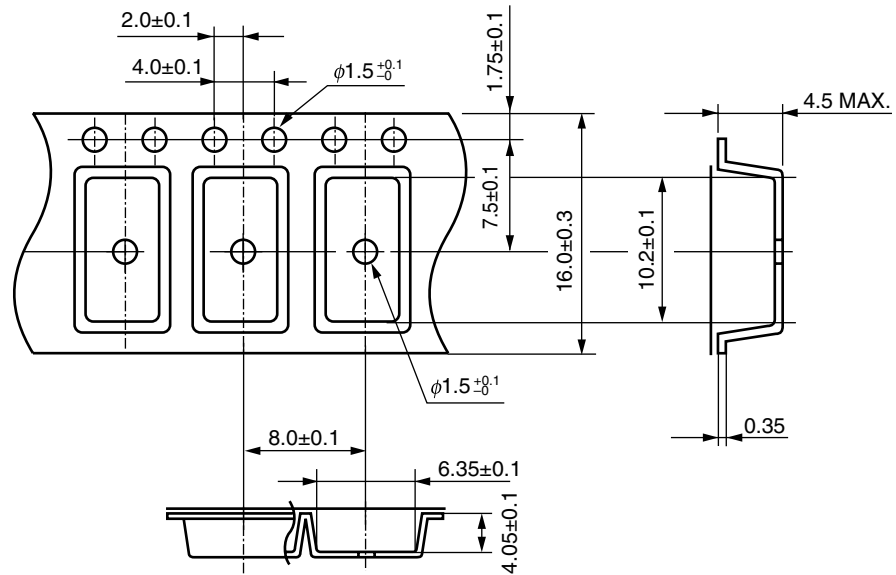
OUTPUT VOLTAGE vs. SUPPLY VOLTAGE



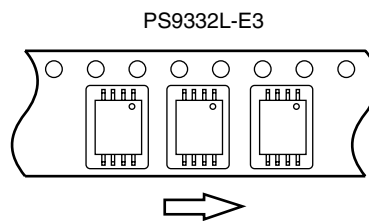
Remark The graphs indicate nominal characteristics.

TAPING SPECIFICATIONS (UNIT: mm)

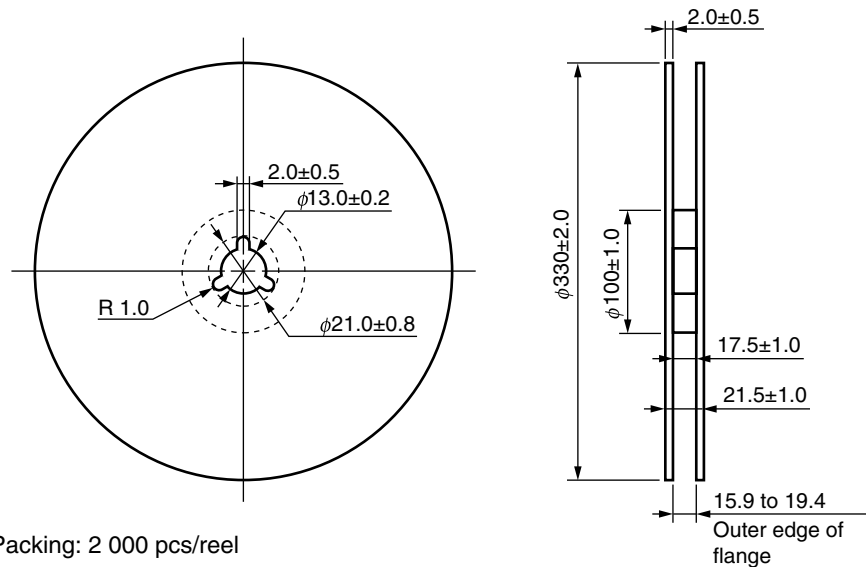
Outline and Dimensions (Tape)



Tape Direction

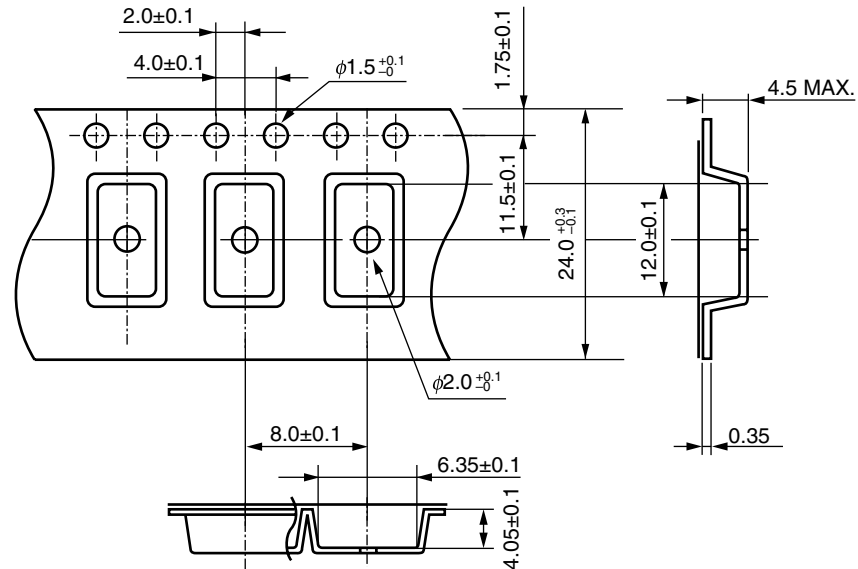


Outline and Dimensions (Reel)

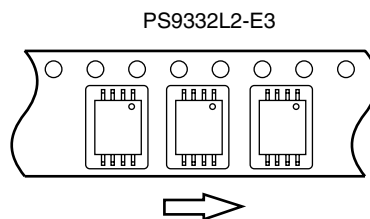


Packing: 2 000 pcs/reel

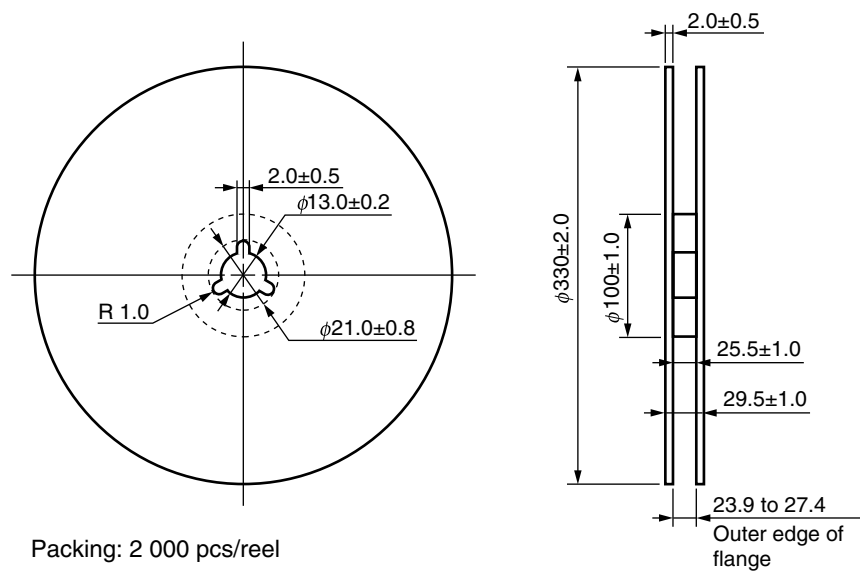
Outline and Dimensions (Tape)



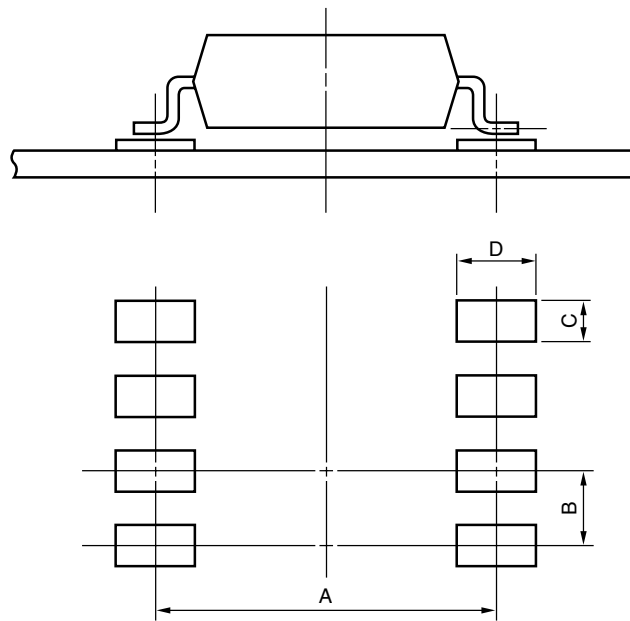
Tape Direction



Outline and Dimensions (Reel)



RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)



Part Number	Lead Bending	A	B	C	D
PS9332L	lead bending type (Gull-wing) for surface mount	9.2	1.27	0.8	2.2
PS9332L2	lead bending type (Gull-wing) for long creepage distance (surface mount)	10.2	1.27	0.8	2.2

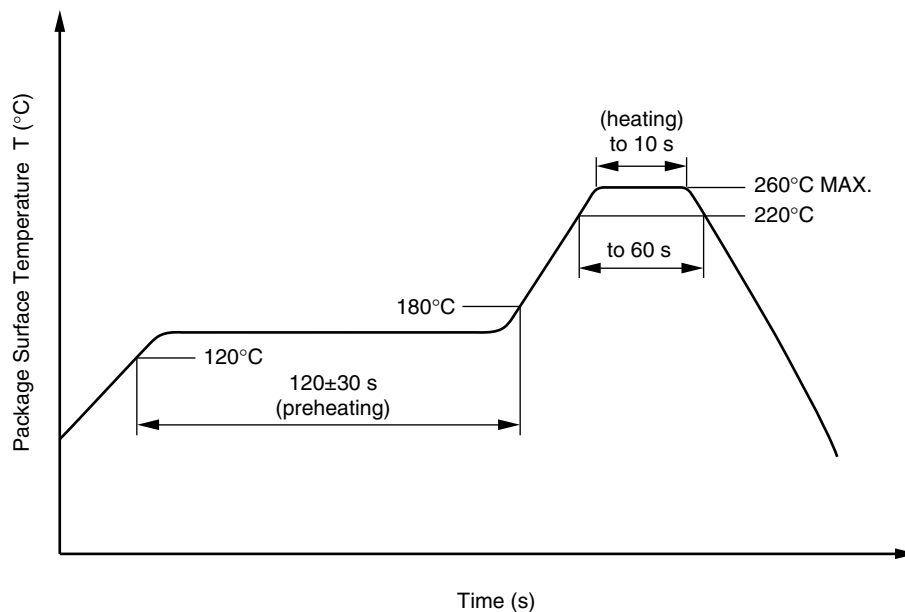
NOTES ON HANDLING

1. Recommended soldering conditions

(1) Infrared reflow soldering

- | | |
|---|--|
| • Peak reflow temperature | 260°C or below (package surface temperature) |
| • Time of peak reflow temperature | 10 seconds or less |
| • Time of temperature higher than 220°C | 60 seconds or less |
| • Time to preheat temperature from 120 to 180°C | 120 ± 30 s |
| • Number of reflows | Three |
| • Flux | Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.) |

Recommended Temperature Profile of Infrared Reflow



(2) Wave soldering

- | | |
|-------------------------|--|
| • Temperature | 260°C or below (molten solder temperature) |
| • Time | 10 seconds or less |
| • Preheating conditions | 120°C or below (package surface temperature) |
| • Number of times | One (Allowed to be dipped in solder including plastic mold portion.) |
| • Flux | Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.) |

(3) Soldering by Soldering Iron

- | | |
|--|--|
| • Peak Temperature (lead part temperature) | 350°C or below |
| • Time (each pins) | 3 seconds or less |
| • Flux | Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.) |

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead

(4) Cautions

- | | |
|----------|--|
| • Fluxes | Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent. |
|----------|--|

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

USAGE CAUTIONS

1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
2. Board designing
 - (1) By-pass capacitor of more than 1.0 μF is used between V_{CC} and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is no more than 10 mm.
 - (2) When designing the printed wiring board, ensure that the pattern of the IGBT collectors/emitters is not too close to the input block pattern of the photocoupler.

If the pattern is too close to the input block and coupling occurs, a sudden fluctuation in the voltage on the IGBT output side might affect the photocoupler's LED input, leading to malfunction or degradation of characteristics. (If the pattern needs to be close to the input block, to prevent the LED from lighting during the off state due to the abovementioned coupling, design the input-side circuit so that the bias of the LED is reversed, within the range of the recommended operating conditions, and be sure to thoroughly evaluate operation.)
 - (3) Pin 2,4 (which is an NC^{*1} pin) can either be connected directly to the GND pin on the LED side or left open. Unconnected pins should not be used as a bypass for signals or for any other similar purpose because this may degrade the internal noise environment of the device.

Note: *1. NC: Non-Connection (No Connection).
3. Make sure the rise/fall time of the forward current is 0.5 μs or less.
4. In order to avoid malfunctions, make sure the rise/fall slope of the supply voltage is 3 V/ μs or less.
5. Avoid storage at a high temperature and high humidity.

<R> SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

Parameter	Symbol	Spec.	Unit
Maximum repetitive peak operating isolation voltage	U_{IORM}	1 130	V_{peak}
Partial discharge test voltage at 100% production test $U_{pr} = 1.875 \times U_{IORM}$, Method b, $t_m=1\text{sec}$, $p_d < 5 \text{ pC}$	U_{pr}	1 808	V_{peak}
Partial discharge test voltage at Type test and Sample test $U_{pr} = 1.875 \times U_{IORM}$, Method a, $t_m=10\text{sec}$, $p_d < 5 \text{ pC}$	U_{pr}	2 119	V_{peak}
Maximum transient isolation voltage (Transient overvoltage $t_{ini}=60\text{sec}$)	U_{IOTM}	8 000	V_{peak}
Installation classification (IEC 60664/ DIN EN 60664-1/ VDE0110 Part 1) for rated mains voltage $\leq 300 \text{ Vr.m.s.}$ for rated mains voltage $\leq 600 \text{ Vr.m.s.}$ for rated mains voltage $\leq 1\,000 \text{ Vr.m.s.}$		I - IV I - IV I - III	
Comparative tracking index (IEC 60112/ DIN EN 60112/ VDE 0303 Part 11)	CTI	175	
Material group (DIN EN 60664-1/ VDE0110 Part 1)		III a	
Pollution degree (DIN EN 60664-1/ VDE0110 Part 1)		2	
Climatic category (IEC 60068-1/ DIN EN 60068-1)		40/125/21	
Operating temperature range	T_A	-40 to +125	$^{\circ}\text{C}$
Storage temperature range	T_{stg}	-55 to +150	$^{\circ}\text{C}$
Isolation resistance, minimum value $V_{IO} = 500 \text{ Vdc}$ at $T_A = 25^{\circ}\text{C}$ $V_{IO} = 500 \text{ Vdc}$ at $T_A \text{ MAX.}$ at least 100°C	Ris MIN. Ris MIN.	10^{12} 10^{11}	Ω Ω
Safety limiting values ratings (maximum allowable in the event of a fault or a failure, see thermal derating curve)			
Maximum ambient safety temperature	T_s	175	$^{\circ}\text{C}$
Maximum input current	I_{si}	400	mA
Maximum output power	P_{so}	700	mW
Isolation resistance at $V_{IO}= 500 \text{ Vdc}$, $T_A=T_s$	Ris MIN.	10^9	Ω

Caution	GaAs Products	This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points. • Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below. 1. Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials. 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal. • Do not burn, destroy, cut, crush, or chemically dissolve the product. • Do not lick the product or in any way allow it to enter the mouth.
----------------	---------------	--

Revision History	PS9332L, PS9332L2 Data Sheet
-------------------------	-------------------------------------

Rev.	Date	Description	
		Page	Summary
0.01	Nov 30, 2012	–	First edition issued
1.00	Sep 06, 2013	Throughout	“Preliminary Data Sheet” is changed to “Data Sheet.”
		p.1	Addition of Safety standards
		p.3	Addition of ORDERING INFORMATION
		p.4	Modification of ABSOLUTE MAXIMUM RATINGS
		p.5	Modification of ELECTRICAL / SWITCHING CHARACTERISTICS
		p.6 to 7	Modification of TEST CIRCUIT
		p.8 to 11	Addition of TYPICAL CHARACTERISTICS
		p.17	Addition of SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

All trademarks and registered trademarks are the property of their respective owners.

Notice

1. Descriptions of circuits, software and other related information in this document are provided only to illustrate the operation of semiconductor products and application examples. You are fully responsible for the incorporation of these circuits, software, and information in the design of your equipment. Renesas Electronics assumes no responsibility for any losses incurred by you or third parties arising from the use of these circuits, software, or information.
 2. Renesas Electronics has used reasonable care in preparing the information included in this document, but Renesas Electronics does not warrant that such information is error free. Renesas Electronics assumes no liability whatsoever for any damages incurred by you resulting from errors in or omissions from the information included herein.
 3. Renesas Electronics does not assume any liability for infringement of patents, copyrights, or other intellectual property rights of third parties by or arising from the use of Renesas Electronics products or technical information described in this document. No license, express, implied or otherwise, is granted hereby under any patents, copyrights or other intellectual property rights of Renesas Electronics or others.
 4. You should not alter, modify, copy, or otherwise misappropriate any Renesas Electronics product, whether in whole or in part. Renesas Electronics assumes no responsibility for any losses incurred by you or third parties arising from such alteration, modification, copy or otherwise misappropriation of Renesas Electronics product.
 5. Renesas Electronics products are classified according to the following two quality grades: "Standard" and "High Quality". The recommended applications for each Renesas Electronics product depends on the product's quality grade, as indicated below.

"Standard": Computers; office equipment; communications equipment; test and measurement equipment; audio and visual equipment; home electronic appliances; machine tools; personal electronic equipment; and industrial robots etc.

"High Quality": Transportation equipment (automobiles, trains, ships, etc.); traffic control systems; anti-disaster systems; anti-crime systems; and safety equipment etc.

Renesas Electronics products are neither intended nor authorized for use in products or systems that may pose a direct threat to human life or bodily injury (artificial life support devices or systems, surgical implantations etc.), or may cause serious property damages (nuclear reactor control systems, military equipment etc.). You must check the quality grade of each Renesas Electronics product before using it in a particular application. You may not use any Renesas Electronics product for any application for which it is not intended. Renesas Electronics shall not be in any way liable for any damages or losses incurred by you or third parties arising from the use of any Renesas Electronics product for which the product is not intended by Renesas Electronics.
 6. You should use the Renesas Electronics products described in this document within the range specified by Renesas Electronics, especially with respect to the maximum rating, operating supply voltage range, movement power voltage range, heat radiation characteristics, installation and other product characteristics. Renesas Electronics shall have no liability for malfunctions or damages arising out of the use of Renesas Electronics products beyond such specified ranges.
 7. Although Renesas Electronics endeavors to improve the quality and reliability of its products, semiconductor products have specific characteristics such as the occurrence of failure at a certain rate and malfunctions under certain use conditions. Further, Renesas Electronics products are not subject to radiation resistance design. Please be sure to implement safety measures to guard them against the possibility of physical injury, and injury or damage caused by fire in the event of the failure of a Renesas Electronics product, such as safety design for hardware and software including but not limited to redundancy, fire control and malfunction prevention, appropriate treatment for aging degradation or any other appropriate measures. Because the evaluation of microcomputer software alone is very difficult, please evaluate the safety of the final products or systems manufactured by you.
 8. Please contact a Renesas Electronics sales office for details as to environmental matters such as the environmental compatibility of each Renesas Electronics product. Please use Renesas Electronics products in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive. Renesas Electronics assumes no liability for damages or losses occurring as a result of your noncompliance with applicable laws and regulations.
 9. Renesas Electronics products and technology may not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable domestic or foreign laws or regulations. You should not use Renesas Electronics products or technology described in this document for any purpose relating to military applications or use by the military, including but not limited to the development of weapons of mass destruction. When exporting the Renesas Electronics products or technology described in this document, you should comply with the applicable export control laws and regulations and follow the procedures required by such laws and regulations.
 10. It is the responsibility of the buyer or distributor of Renesas Electronics products, who distributes, disposes of, or otherwise places the product with a third party, to notify such third party in advance of the contents and conditions set forth in this document, Renesas Electronics assumes no responsibility for any losses incurred by you or third parties as a result of unauthorized use of Renesas Electronics products.
 11. This document may not be reproduced or duplicated in any form, in whole or in part, without prior written consent of Renesas Electronics.
 12. Please contact a Renesas Electronics sales office if you have any questions regarding the information contained in this document or Renesas Electronics products, or if you have any other inquiries.
- (Note 1) "Renesas Electronics" as used in this document means Renesas Electronics Corporation and also includes its majority-owned subsidiaries.
- (Note 2) "Renesas Electronics product(s)" means any product developed or manufactured by or for Renesas Electronics.



SALES OFFICES

Renesas Electronics Corporation

<http://www.renesas.com>

Refer to "<http://www.renesas.com/>" for the latest and detailed information.

California Eastern Laboratories, Inc.
4590 Patrick Henry Drive, Santa Clara, California 95054, U.S.A.
Tel: +1-408-919-2500, Fax: +1-408-988-0279

Renesas Electronics Europe Limited
Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K
Tel: +44-1628-651-700, Fax: +44-1628-651-804

Renesas Electronics Europe GmbH
Arcadiastrasse 10, 40472 Düsseldorf, Germany
Tel: +49-211-65030, Fax: +49-211-6503-1327

Renesas Electronics (China) Co., Ltd.
7th Floor, Quantum Plaza, No.27 ZhiChunLu Haidian District, Beijing 100083, P.R.China
Tel: +86-10-8235-1155, Fax: +86-10-8235-7679

Renesas Electronics (Shanghai) Co., Ltd.
Unit 204, 205, AZIA Center, No.1233 Lujiazui Ring Rd., Pudong District, Shanghai 200120, China
Tel: +86-21-5877-1818, Fax: +86-21-6887-7858 / -7898

Renesas Electronics Hong Kong Limited
Unit 1601-1613, 16/F., Tower 2, Grand Century Place, 193 Prince Edward Road West, Mongkok, Kowloon, Hong Kong
Tel: +852-2886-9318, Fax: +852 2886-9022/9044

Renesas Electronics Taiwan Co., Ltd.
13F, No. 363, Fu Shing North Road, Taipei, Taiwan
Tel: +886-2-8175-9600, Fax: +886 2-8175-9670

Renesas Electronics Singapore Pte. Ltd.
80 Bendemeer Road, Unit #06-02 Hyflux Innovation Centre Singapore 339949
Tel: +65-6213-0200, Fax: +65-6213-0300

Renesas Electronics Malaysia Sdn.Bhd.
Unit 906, Block B, Menara Amcorp, Amcorp Trade Centre, No. 18, Jln Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia
Tel: +60-3-7955-9390, Fax: +60-3-7955-9510

Renesas Electronics Korea Co., Ltd.
11F., Samik Lavied' or Bldg., 720-2 Yeoksam-Dong, Kangnam-Ku, Seoul 135-080, Korea
Tel: +82-2-558-3737, Fax: +82-2-558-5141

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Renesas Electronics:

[PS9332L-V-AX](#) [PS9332L-V-E3-AX](#) [PS9332L2-E3-AX](#) [PS9332L2-V-AX](#) [PS9332L-AX](#) [PS9332L2-V-E3-AX](#)
[PS9332L2-AX](#) [PS9332L-E3-AX](#)



**Стандарт
Электрон
Связь**

Мы молодая и активно развивающаяся компания в области поставок электронных компонентов. Мы поставляем электронные компоненты отечественного и импортного производства напрямую от производителей и с крупнейших складов мира.

Благодаря сотрудничеству с мировыми поставщиками мы осуществляем комплексные и плановые поставки широчайшего спектра электронных компонентов.

Собственная эффективная логистика и склад в обеспечивает надежную поставку продукции в точно указанные сроки по всей России.

Мы осуществляем техническую поддержку нашим клиентам и предпродажную проверку качества продукции. На все поставляемые продукты мы предоставляем гарантию .

Осуществляем поставки продукции под контролем ВП МО РФ на предприятия военно-промышленного комплекса России , а также работаем в рамках 275 ФЗ с открытием отдельных счетов в уполномоченном банке. Система менеджмента качества компании соответствует требованиям ГОСТ ISO 9001.

Минимальные сроки поставки, гибкие цены, неограниченный ассортимент и индивидуальный подход к клиентам являются основой для выстраивания долгосрочного и эффективного сотрудничества с предприятиями радиоэлектронной промышленности, предприятиями ВПК и научно-исследовательскими институтами России.

С нами вы становитесь еще успешнее!

Наши контакты:

Телефон: +7 812 627 14 35

Электронная почта: sales@st-electron.ru

Адрес: 198099, Санкт-Петербург,
Промышленная ул, дом № 19, литера Н,
помещение 100-Н Офис 331